DATA SHEET



MOS FIELD EFFECT TRANSISTOR **2SK2485**

SWITCHING **N-CHANNEL POWER MOS FET INDUSTRIAL USE**

DESCRIPTION

The 2SK2485 is N-Channel MOS Field Effect Transistor designed for high voltage switching applications.

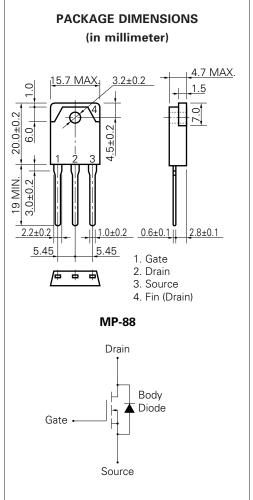
FEATURES

- Low On-Resistance
- RDS (on) = 2.8Ω (VGS = 10 V, ID = 3.0 A)
- Low Ciss Ciss = 1 200 pF TYP.
- High Avalanche Capability Ratings

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage	VDSS	900	V
Gate to Source Voltage	Vgss	±30	V
Drain Current (DC)	D (DC)	±6.0	А
Drain Current (pulse)*	D (pulse)	±12	А
Total Power Dissipation (T _c = 25 $^{\circ}$ C)	P T1	100	W
Total Power Dissipation (T _A = 25 $^{\circ}$ C)	Рт2	3.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg –5	55 to +150	°C
Single Avalanche Current**	las	6.0	А
Single Avalanche Energy**	Eas	42.3	mJ
* PW \leq 10 μ s, Duty Cycle \leq 1 %			

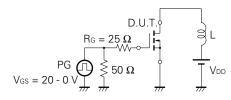
** Starting T_{ch} = 25 °C, R_G = 25 Ω , V_{GS} = 20 V \rightarrow 0

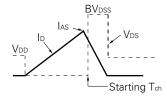


ELECTRICAL CHARACTERISTICS (TA = 25 $^{\circ}$ C)

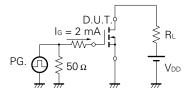
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-Resistance	RDS (on)		2.2	2.8	Ω	$V_{GS} = 10 \text{ V}, \text{ Id} = 3.0 \text{ A}$
Gate to Source Cutoff Voltage	VGS (off)	2.5		3.5	V	V _{DS} = 10 V, I _D = 1 mA
Forward Transfer Admittance	y _{fs}	2.0			S	$V_{DS} = 10 V, I_{D} = 3.0 A$
Drain Leakage Current	IDSS			100	μΑ	$V_{DS} = V_{DSS}, V_{GS} = 0$
Gate to Source Leakage Current	Igss			±100	nA	$V_{GS} = \pm 30 \text{ V}, \text{ V}_{DS} = 0$
Input Capacitance	Ciss		1200		pF	V _{DS} = 10 V
Output Capacitance	Coss		170		pF	V _{GS} = 0
Reverse Transfer Capacitance	Crss		30		pF	f = 1 MHz
Turn-On Delay Time	td (on)		20		ns	ID = 3.0 A
Rise Time	tr		10		ns	Vgs = 10 V
Turn-Off Delay Time	td (off)		70		ns	V _{DD} = 150 V
Fall Time	tf		15		ns	$R_G = 10 \ \Omega R_L = 50 \ \Omega$
Total Gate Charge	QG		40		nC	ID = 6.0 A
Gate to Source Charge	Qgs		7		nC	$V_{DD} = 450 V$
Gate to Drain Charge	Qgd		17		nC	Vgs = 10 V
Body Diode Forward Voltage	VF (S-D)		1.0		V	IF = 6.0 A, VGS = 0
Reverse Recovery Time	trr		740		ns	IF = 6.0 A, VGS = 0
Reverse Recovery Charge	Qrr		4.0		μC	di/dt = 50 A/µs

Test Circuit 1 Avalanche Capability

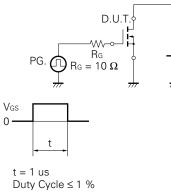


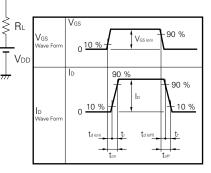


Test Circuit 3 Gate Charge

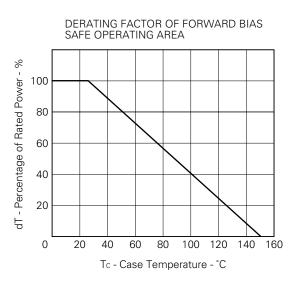


Test Circuit 2 Switching Time

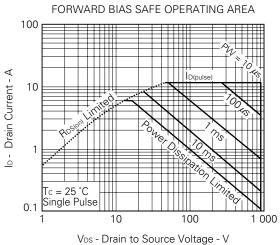




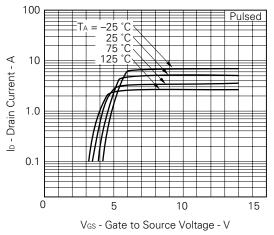
The application circuits and their parameters are for references only and are not intended for use in actual design-in's.

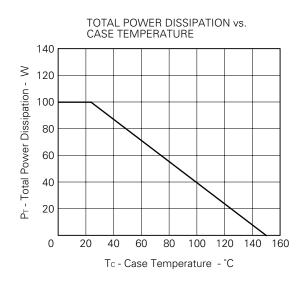




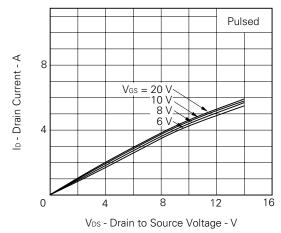


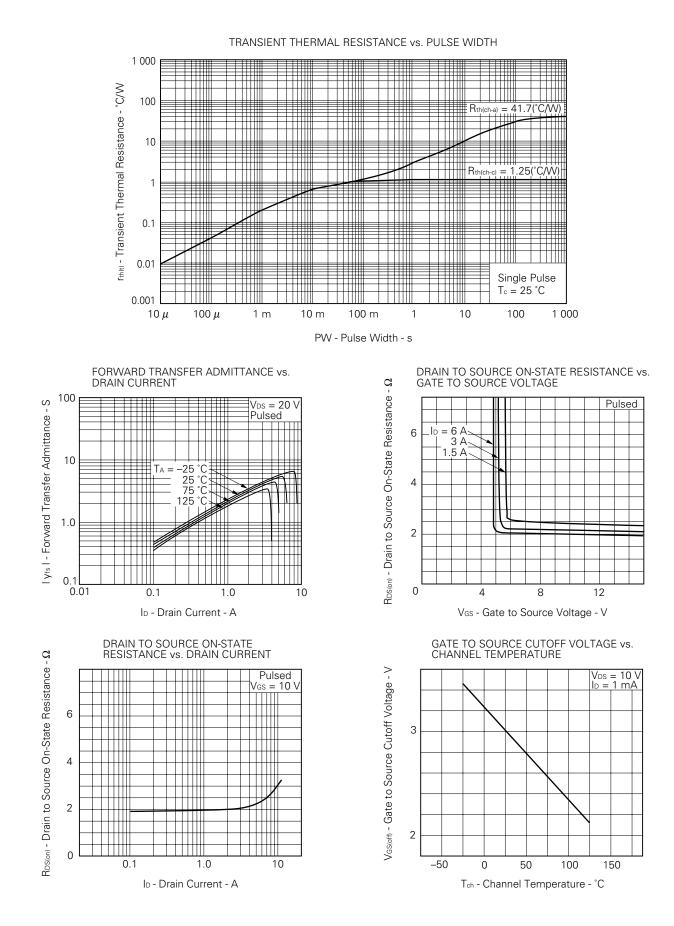
FORWARD TRANSFER CHARACTERISTICS





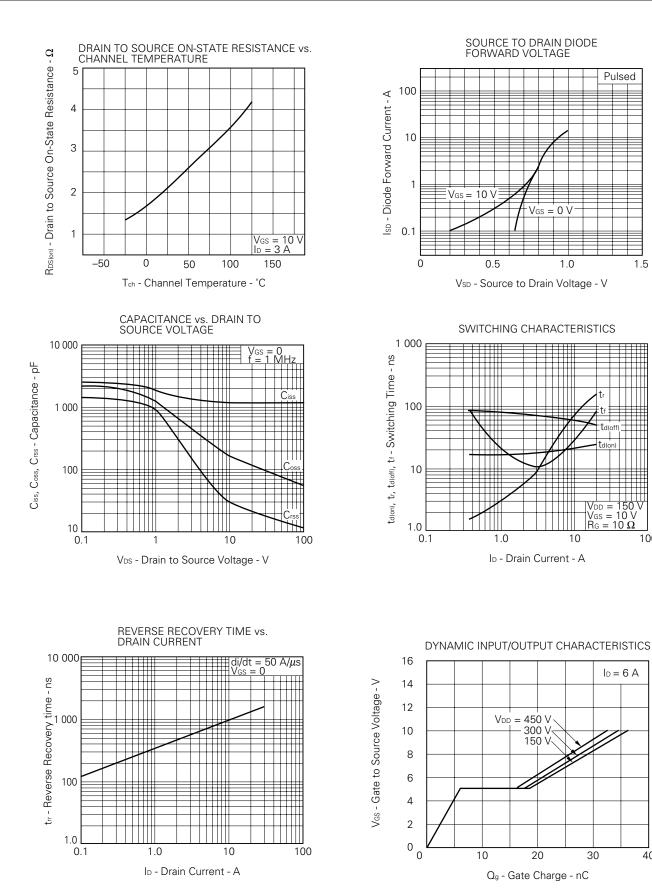






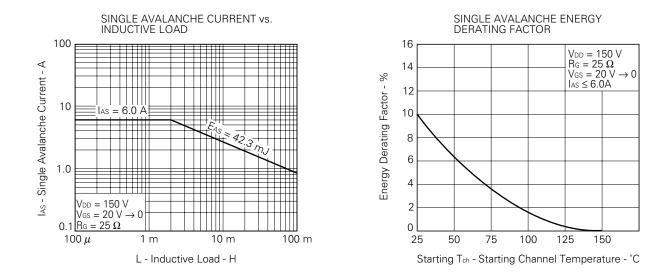
1.5

100



5

40



REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	IEI-1207
Semiconductor device package manual.	IEI-1213
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	MF-1134
Power MOS FET features and application switching power supply.	TEA-1034
Application circuits using Power MOS FET.	TEA-1035
Safe operating area of Power MOS FET.	TEA-1037

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Anti-radioactive design is not implemented in this product.

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